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CUSTOMER · CDE012

SAMPLE CODE · SH320240T023-IHC13

MASS PRODUCTION CODE . PH320240T023-IHC13

PCAP FIRMWARE VERSION : CW035012_V2_20171117.bin

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 003

DRAWING NO. (Ver.) . JLMD-PH320240T023-IHC13_002

PACKAGING NO. (Ver.) . JPKG-PH320240T023-IHC13_001

Customer Approved

Date:

POWERTIP
2020.05.11

JS RD APPROVED

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☐ Preliminary specification for design input

Specification for sample approval

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History of Version

Date	Ver.	Edi.	Description	Page	Design by
03/25/2020	01	001	New Sample	(-	俞承澤
04/24/2020	01	002	Update Cover Modify Power Supply for Backlight Unit	- 5	俞承澤
05/08/2020	01	003	Add "see Note1" Mark Update Drawing	14	俞承澤

Total: 35 Pages



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Appendix : LCM Drawing Packaging

Note : For detailed information please refer to IC data sheet :

Primacy(TFT LCD): Himax: HX8238-D



1. SPECIFICATIONS

1.1 Features

Item	Standard Value		
Display Resolution	320 * (RGB) * 240 Dots		
LCD Type	a-Si TFT , Normally white , Transmissive type		
Touch panel	Projective capacitive touch panel True Multi-touch with up to 5 Points of Absolution		
Screen size(inch)	3.5 inch		
Viewing Direction	6 O'clock		
Color configuration	R.G.B. Vertical Stripe		
Backlight Type	LED B/L		
Interface	24 Bits RGB Interface		
Other (controller / driver IC)	Himax: HX8238-D		
ROHS	THIS PRODUCT CONFORMS THE ROHS OF PTC Detail information please refer website: http://www.powertip.com.tw/news.php?area id view=1085560481/		

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension(T/P)	76.9(W) x 63.9 (L) x 5.05 (H)	mm

LCD panel

Item	Standard Value	Unit
Active Area	70.08 (W) * 52.56 (L)	mm

Touch panel

Item	Standard Value	Unit
Ink Opening	71.08 (W) * 53.56 (L)	mm

Note: For detailed information please refer to LCM drawing.



1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit	Remark
Power Supply Voltage	VDD	GND=0	-0.3	+3.96	V	
Power Supply Voltage	VCC	GND=0	-0.3	+23.0	V	
Operating Temperature	T _{OP} (Ts)	Note 1	-20	+70	°C	-
Storage Temperature	T _{ST} (Ta)	Note 2	-30	+80	°C	
Storage Humidity	H _D	Ta ≤ 60 °C	10	90	%RH	

The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

Note 1: Ts is the temperature of panel's surface.

Note 2: Ta is the ambient temperature of samples

1.4 DC Electrical Characteristics

Module $Ta = 25^{\circ}C$

Item	Symbol Condition		Min.	Тур.	Max.	Unit
Power Supply for TFT Panel	VDD	GND=0V	3.0	3.3	3.6	V
Power Supply for Backlight Unit	VCC	GND=0V	5	12	15	V
Input Valtage for TET Danel	VIH	GND=0V	0.7VDD	ı	VDD	V
Input Voltage for TFT Panel	VIL	V _{IL} GND=0V		1	0.3VDD	V
Supply Current for TFT Panel	IDD	IDD@VDD=3.3V	-	11	17	mA
Supply Current for Backlight Unit	ICC	ICC@VCC=5V	-	100	150	mA
Supply Current for Backlight Offic	100	ICC@VCC=12V	-	50	75	mA
Input Voltage for PWM Signal	VPH	GND=0V	1.2	ı	-	V
input voltage for F vvivi Signal	VPL	GND=0V	-	ı	0.4	V
Dimming Clock Rate	fP	GND=0V	5	-	100	KHz



1.5 Optical Characteristics

VDD=3.3V, Ta=25°C

Item		Symbol	Condition	Min.	Тур.	Max.	unit	-
Response time		Tr + Tf	-	-	40	60	ms	Note2
	Тор	θ+		-	60	-		
Viouing angle	Bottom	θ-	00 > 40	-	60	-	Dog	Note4
Viewing angle	Left	θL	CR ≥ 10	-	60	1	Deg.	NOIE4
	Right	θR		-	60	1		
Contrast ration	0	CR	-	500	600	-	-	Note3
	White	Х		0.27	0.32	0.37		
	vviille	Y		0.30	0.35	0.40		
	Red	Х		0.59	0.64	0.69		
Color of CIE		Y	VCC=12V	0.29	0.34	0.39		
Coordinate (LCD & B/L & T/P)	Croon	Х	PWM="High" (Duty=100%)	0.29	0.34	0.39	_	
,	Green	Y	(Duty=100%)	0.56	0.61	0.66		Noted
	Blue	Х		0.09	0.14	0.19		Note1
		Y		0.03	0.08	0.13		
Average Brightness Pattern=white display (LCD & B/L & T/P)*1		IV	VCC=12V PWM="High"	680	850	-	cd/m ²	
Uniformity (LCD & B/L & T/	P)*2	∆B	(Duty=100%)	70	-	-	%	



Note 1:

*1 : △B=B(min) / B(max) * 100%

*2 : Measurement Condition for Optical Characteristics:

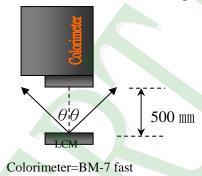
a : Environment: 25°C±5°C / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.

b : Measurement Distance: 500 \pm 50 mm \rightarrow (θ = 0°)

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.

d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





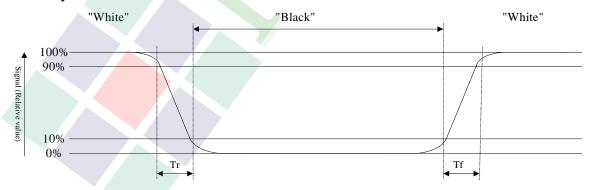
To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

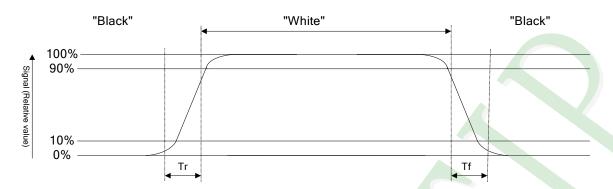
Refer to figure as below:

Normally White





Normally Black



Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

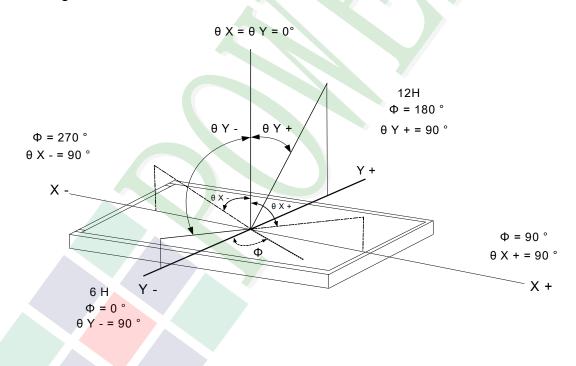
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle:

Refer to figure as below:





1.6 Backlight Characteristics

Maximum Ratings

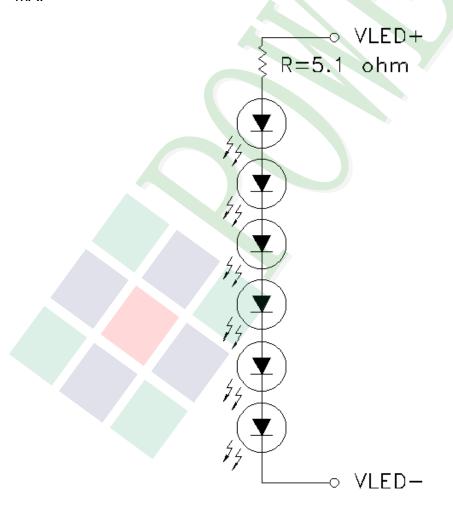
Item	Symbol	Min.	Max.	Unit	Remark
LED Forward Current	l _F	30		mA	One LED
LED Reverse Voltage	VR	Ę	5	V	Olle LED

Electrical / Optical Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
LED Voltage	VL	18	19	19.8	V	Note1
LED Current	ΙL	-	20	-	mA	-
LED life time	-	50000	-	-	Hr	Note2

Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25℃ and I_L=20mA.

Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and I∟=20mA. The LED life time could be decreased if operating I∟ is larger than 20 mA.





Touch Panel Characteristics

Features

Item	Standard Value
Touch Panel Size	3.5"
Touch type	Projective capacitive touch panel
Input Method	Finger / Multi touch
Output Interface	l ² C
IC	HY4635

I²C Address

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	1	1	1	0	0	0	R/W

Bit 0: 0 for Write / 1 for Read

Mechanical Specifications

Item	Standard Value	Unit
Ink Opening	71.08 (W) * 53.56 (L)	mm
Number of sensing channel	10 (R) x 13 (H)	mm

Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Supply voltage	TPVDD	-	-0.3	3.6	٧
Operating Temperature	Тор	-	-20	70	°C
Storage Temperature	Tst	-	-30	80	°C

Optical Characteristics

Item	Standard Value				
Total light transmittance	85% or more				
Hardness	≥6H				

PCAP Firmware Information

File: CW035012_V2_20171117.bin

SHA-256: F73E1631AD350878F3A179D8C8B3BF0C5C50DB10CBC82BCC84CE396FF45E929E



HYCON I²C Sensitivity command:

Address	Register description	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
0x92	GAIN	R/W	Sensitivity setting, setting range : 05							

Application reference:

Register 0x92=02(Default) without cover lens

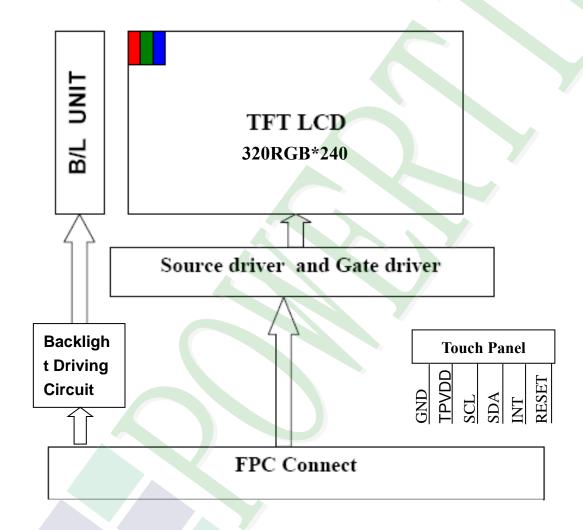
Register 0x92=03 Air gap 0.15mm with cover glass 1mm
Register 0x92=04 Air gap 0.15mm with cover glass 2mm
Register 0x92=05 Air gap 0.15mm with cover glass 3-5mm



2. MODULE STRUCTURE

2.1 Counter Drawing

- 2.1.1 LCM Mechanical Diagram
 - * See Appendix
- 2.1.2 Block Diagram





2.2 Interface Pin Description

TFT LCM Interface

Pin No.	Symbol	Function
1	GND	Power ground.
2	VDD	Power for Digital Circuit.
3	VDD	Power for Digital Circuit.
4	VCC	Power For LED backlight.
5	VCC	Power For LED backlight.
6	PWM	Shutdown & Dimming control input for backlight. Do not allow this pin to float. "Hi" =100%, "Low" = 0%.
7	GND	Power ground.
8	R0	Red Data.
9	R1	Red Data.
10	R2	Red Data.
11	R3	Red Data.
12	GND	Power ground.
13	R4	Red Data.
14	R5	Red Data.
15	R6	Red Data.
16	R7	Red Data.
17	GND	Power ground.
18	G0	Green Data.
19	G1	Green Data.
20	G2	Green Data.
21	G3	Green Data.
22	GND	Power ground.
23	G4	Green Data.
24	G5	Green Data.
25	G6	Green Data.
26	G7	Green Data.
27	GND	Power ground.
28	В0	Blue Data.
29	B1	Blue Data.



Pin No.	Symbol	Function
30	B2	Blue Data.
31	В3	Blue Data.
32	GND	Power ground.
33	B4	Blue Data.
34	B5	Blue Data.
35	B6	Blue Data.
36	B7	Blue Data.
37	GND	Power ground.
38	HS	Line synchronization signal. Horizontal Sync Input.
39	VS	Frame synchronization signal. Vertical Sync Input.
40	GND	Power ground.
41	DE	Display enable pin from controller. Data Input Enable.
42	GND	Power ground.
43	DCLK	Sample clock. Data will be latched at the falling edge of DCLK.
44	GND	Power ground.
45	CS/ ID1	Chip Select. / ID[4:1]These pins select LCM type. See NOTE1
46	SDIN / ID2	SPI Data. / ID[4:1]These pins select LCM type. See NOTE1
47	SCK / ID3	SPI Clock. / ID[4:1]These pins select LCM type. See NOTE1
48	DISPLAY	Display Enable (Hi Active). / ID[4:1]These pins select LCM type.
70	CONTROL/ ID4	See NOTE1
49	/RESET	Global Reset (Low Active).
50	GND	Power ground.

Note1

ID Pins Definition:

	Pin48 I <mark>D4</mark>	Pin 47 ID3	Pin 46 ID2	Pin45 ID1
3.5"	X	0	0	Х
4.3"	X	0	1	Х
5"	Х	1	0	Х
7"	Х	1	1	Х

- 1. Resistor=10k ohm
- 2. "X"=No use .



Capacitive Touch Panel (CTP) Interface

Pin No.	Symbol	Function
1	GND	Ground.
2	TPVDD	Power supply.
3	SCL	I ² C serial Clock.
4	SDA	I ² C serial Data.
5	INT	Indicate coordinate data ready.
6	RESET	System reset signal input, active low.





2.2.1 Refer Initial Code

HX8238-D register configuration is recommended to use the default value (HSP=0, VSP=0, CKP=0, DEP=0).

Note:

HSP: When HSP=0, HS(HSYNC) is negative polarity. When HSP=1, HS(HSYNC) is positive polarity.

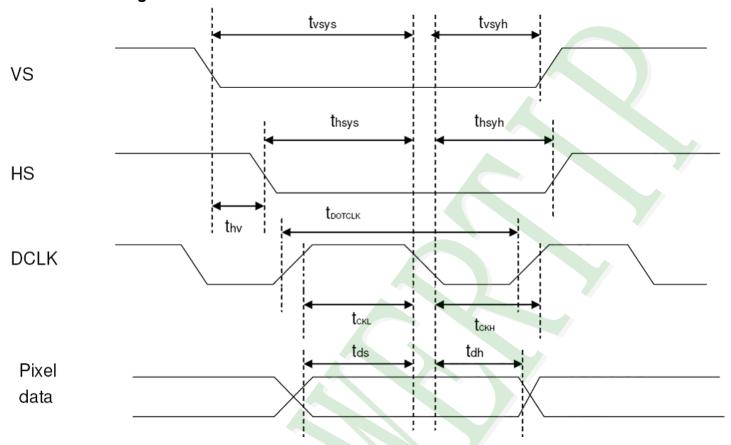
VSP: When VSP=0, VS(VSYNC) is negative polarity. When VSP=1, VS(VSYNC) is positive polarity.

CKP: When CKP=0, data is latched in DCLK falling edge. When CKP=1, data is latched in DCLK rising edge.

DEP: When DEP=0, DE is negative polarity active. When DEP=1, DE is positive polarity active.



2.3 Timing Characteristics 2.3.1 Pixel timing for HX8238-D

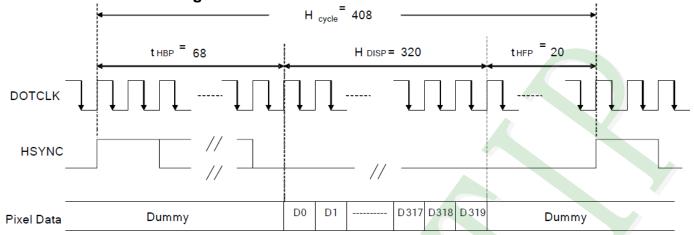


Characteristics	Symbol	Min	Тур	Max	Unit
DCLK Frequency	fDCLK	-	6.5	10	MHz
DCLK Period	tDCLK	100	154	-	ns
Vertical Sync Setup Time	tvsys	20	1	1	ns
Vertical Sync Hold Time	tvsyh	20	1	-	ns
Horizontal Sync Setup Time	thsys	20	-	-	ns
Horizontal Sync Hold Time	thsyh	20	1	•	ns
Phase difference of Sync Signal Falling Edge	thv	1	1	240	tDCLK
DCLK Low Period	tCKL	50	1	1	ns
DCLK High Period	tCKH	50	1	ı	ns
Data Setup Time	tds	12	1	1	ns
Data hold Time	tdh	12	-	-	ns
Reset pulse width	tRES	10	-	-	us

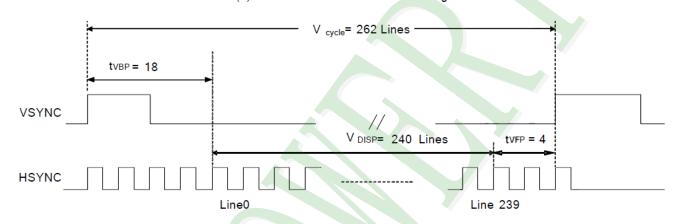
Note: External clock source must be provided to DOTCLK pin of HX8238-A. The driver will not operate if absent of the clocking signal. **Pixel timing**



2.3.2 Data transaction timing for HX8238-D



(a) Horizontal Data Transaction Timing



(b) Vertical Data Transaction Timing

Data transaction timing in parallel RGB (24 bit) interface (SYNC mode)

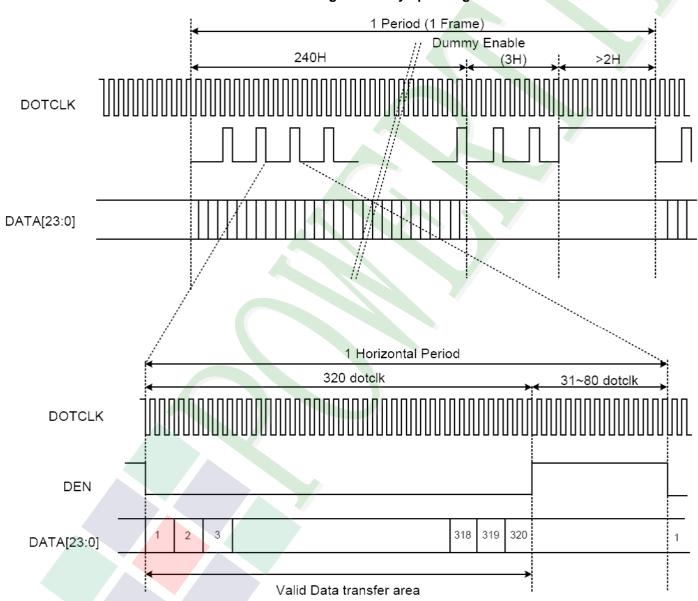
Characteristics	Symbol	Min	Тур	Max	Unit
DOTCLK Frequency	fDOTCLK	-	6.5	10	MHz
DOTCLK Period	tDOTCLK	100	154	-	ns
Horizontal Frequency (Line)	fH	1	14.9	22.35	KHz
Vertical Frequency (Refresh)	fV	1	60	90	Hz
Horizontal Back Porch	tHBP	-	68	-	tDOTCLK
Horizontal Front Porch	tHFP	-	20	-	tDOTCLK
Horizontal Data Start Point	tHBP	1	68	-	tDOTCLK
Horizontal Blanking Period	tHBP + tHFP	1	88	-	tDOTCLK
Horizontal Display Area	HDISP	1	320	-	tDOTCLK
Horizontal Cycle	Hcycle	1	408	450	tDOTCLK
Vertical Back Porch	tVBP	1	18	-	Lines
Vertical Front Porch	tVFP	1	4	1	Lines
Vertical Data Start Point	tVBP	1	18	-	Lines
Vertical Blanking Period	tVBP + tVFP	-	22	-	Lines
Vertical Display Area	VDISP	-	240	-	Lines
Vertical Cycle	Vcycle	-	262	350	Lines

Data transaction timing in normal operating mode



Characteristics	Symbol	Min.	Тур.	Max.	Unit
DOTCLK Frequency	fDOTCLK	- /	6.5	10	MHz
DOTCLK Period	tDOTCLK	100	154	-	ns
Horizontal Blanking Period	tHBP + tHFP	52	88	180	tDOTCLK
Horizontal Display Area	HDISP		320	-	tDOTCLK
Horizontal Cycle	Hcycle	372	408	500	tDOTCLK
Vertical Blanking Period	tVBP + tVFP	2	-	47	Lines
Vertical Display Area	VDISP	-	240	-	Lines
Vertical Cycle	Vcycle	242	-	287	Lines

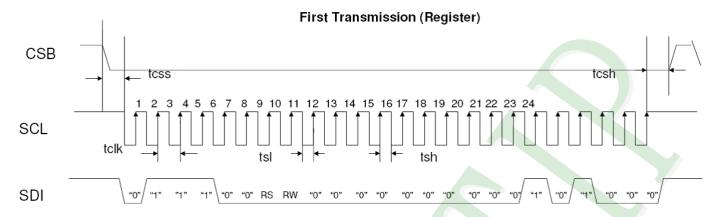
Data transaction timing in DE only operating mode

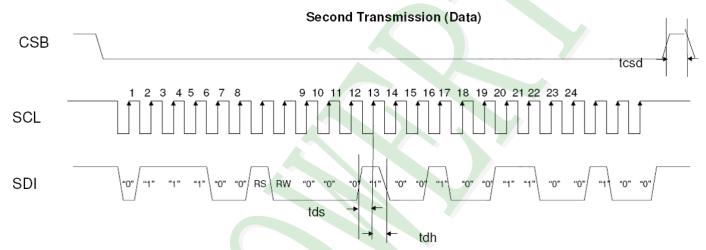


Signal timing in DE mode



2.3.3 SPI Timing Characteristics for HX8238-D





Note: The example transmit "0x1264h" to register R28h. SPID connected to VSS.

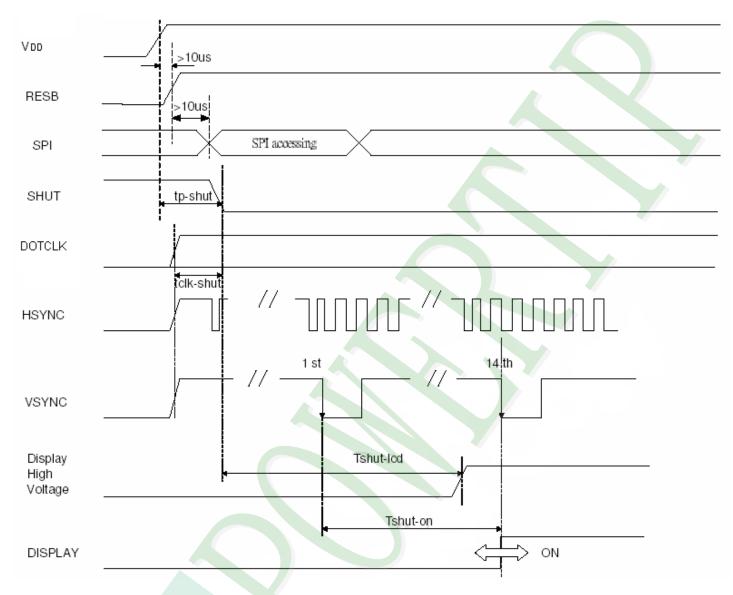
SPI interface timing diagram & transaction example

Characteristics	Symbol	Min	Тур	Max	Unit
Serial Clock Frequency	fclk	-	-	20	MHz
Serial Clock Cycle Time	tclk	50	-	-	ns
Clock Low Width	tsl	25	-	1	ns
Clock High Width	tsh	25	-	-	ns
Chip Select Setup Time	tcss	0	-	1	ns
Chip Select Hold Time	tcsh	10	-	-	ns
Chip Select High Delay Time	tcsd	20	-	-	ns
Data Setup Time	tds	5	-	-	ns
Data Hold Time	tdh	10	-	-	ns

SPI timing



2.4 Power Sequence 2.4.1 Power up sequence



Characteristics	Symbol	Min	Тур	Max	Units
VDD on to falling edge of SHUT	tp-shut	1	-	-	us
DOTCLK	tclk-shut	1	-	-	clk
Falling edge of SHUT to LCD power on	tshut-lcd	•	,	128	ms
Falling edge of SHUT to display start		-	-	14	frame
- 1 line: 408 clk - 1 frame: 262 line -DOTCLK = 6.5MHz	tshut-on	-	166	232.4	ms

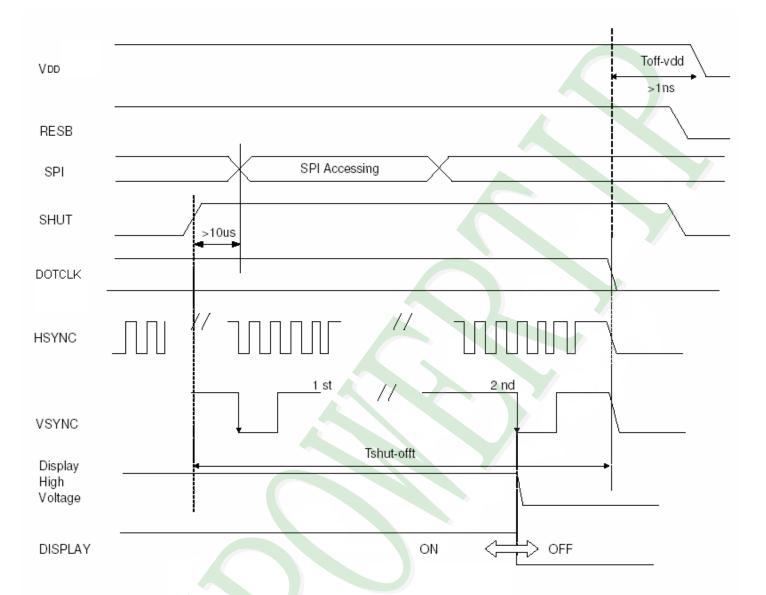
Note: It is necessary to input DOTCLK before the falling edge of SHUT.

Display starts at 10th falling edge of VSYNC after the falling edge of SHUT.

Interface PIN No. 48" Display control" have connected Inverters logic gates to the "SHUT" pin.



2.4.2 Power down sequence



Characteristics	Symbol	Min	Тур	Max	Uni
Rising edge of SHUT to display off		2	-	-	frame
- 1 line: 408 clk - 1 frame: 262 line - DOTCLK = 6.5MHz	tshut-off	33.4	-	-	ms
Input-signal-off to VDD off	toff-vdd	1	-	-	us

Note: DOTCLK must be maintained at lease 2 frames after the rising edge of SHUT.

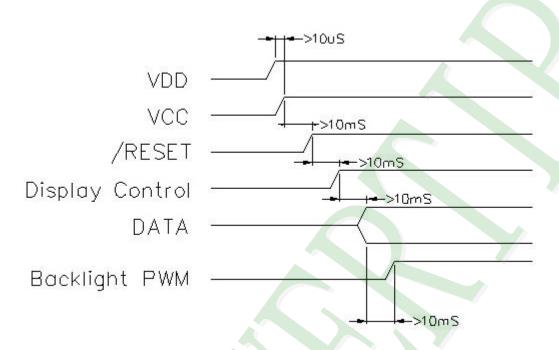
Display become off at the 2nd falling edge of VSYNC after the falling edge of SHUT.

If RESET signal is necessary for power down, provide it after the 2-frames-cycle of the SHUT period.

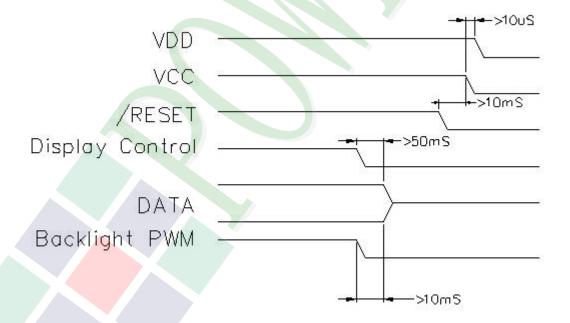


2.4.3 Power Timing Characteristics of Backlight

POWER ON



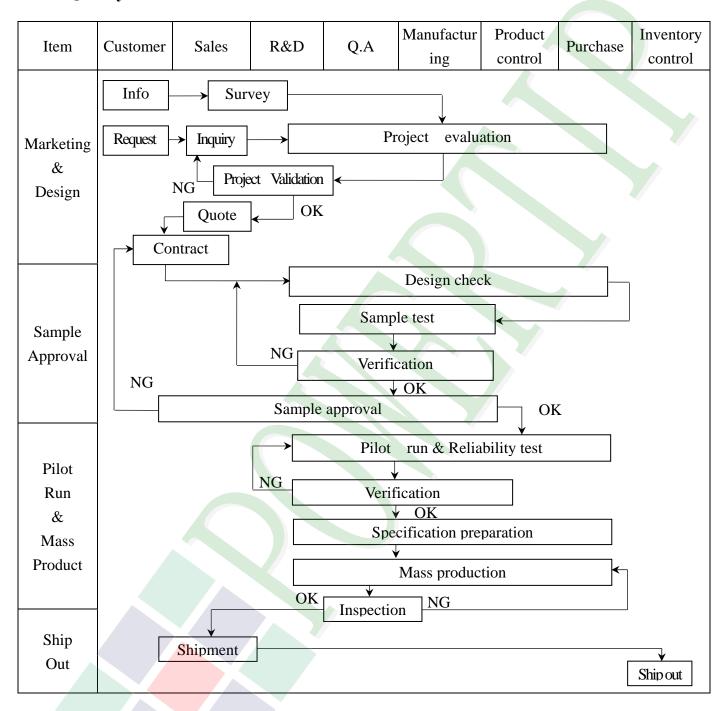
POWER OFF



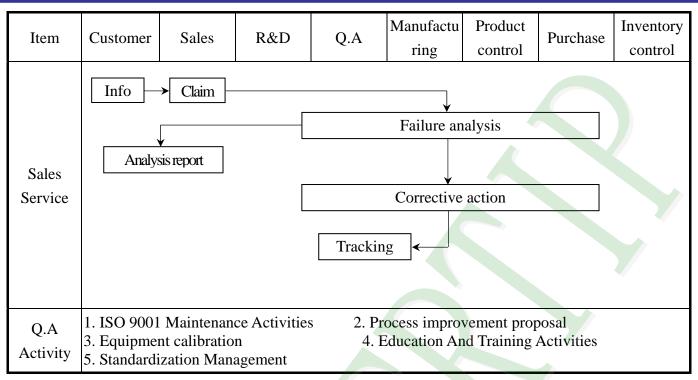


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart



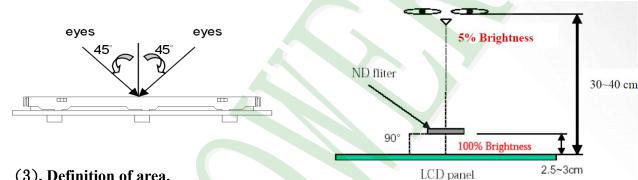




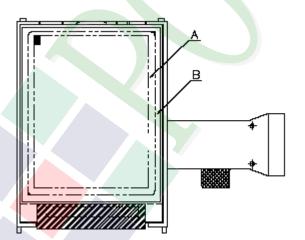


3.2. Inspection Specification

- ◆Scope: The document shall be applied to TFT-LCD Module for 3, 5" -15" (Ver.B01).
- ♦ Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level II.
- **◆**Equipment: Gauge, MIL-STD, Powertip Tester, Sample
- ◆Defect Level: Major Defect AQL: 0. 4; Minor Defect AQL: 1. 5
- **♦**OUT Going Defect Level: Sampling.
- ◆Standard of the product appearance test:
 - a. Manner of appearance test:
 - (1). The test best be under 20W×2 fluorescent light(about 300lux ~500lux) , and distance of view must be at 30~40 cm.
 - (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



◆Specification For TFT-LCD Module 3. 5" ~15":

NO	Item	Criterion	Level			
		1. 1The part number is inconsistent with work order of production.	Major			
01	Product condition	1. 2 Mixed product types.	Major			
		1. 3 Assembled in inverse direction.	Major			
02	Quantity	2. 1The quantity is inconsistent with work order of production.	Major			
03	Outline dimension	3. 1Product dimension and structure must conform to structure diagram.	Major			
		4. 1 Missing line character and icon.	Major			
		4. 2 No function or no display.	Major			
0.4	Electrical Testing	4. 3 Display malfunction.				
04		4. 4 LCD viewing angle defect.				
		4. 5 Current consumption exceeds product specifications.				
		4. 6Mura cannot be seen through 5% ND filter at 50% Gray, should be judged by the viewing angle of 90 degree.				
		Item Acceptance (Q'ty)				
	Dot defect	Bright Dot ≤ 4				
		Defect Joint Dot ≤ 3				
05	(Bright dot, Dark dot)	Total ≤ 7	Minor			
	Daik uui)					
	On -display	5.1 Inspection pattern: full white, full black, Red, Green and				
		blue screens.				
		5. 2 It is defined as dot defect if defect area >1/2 dot.				
		 5. 3 The distance between two dot defect ≥5 mm. 5. 4 Bright dot that can not be seen through 5% ND filter. 				
		o, T Dight dot that can not be seen through 3/0 11D meet.				



igspace Specification For TFT-LCD Module 3. 5" ~15":

NO	Item	Criterion						
	Black or white Dot, scratch, contamination Round type	6. 1 Round type (Non-display or display):						
06	$\Phi = (x+y)/2$ Line type $L \mapsto L$	$ \begin{array}{ c c c c c c c c c }\hline & \text{module size} & Length & Width (W) & Acceptance (Q'ty) \\\hline & & & & & & & & & & & & & & & & & & $	Minor					
07	Polarizer	Dimension (diameter: Φ)Acceptance (Q'ty) A areaΦ ≤ 0.25 Ignore0.25 $< Φ \leq 0.50$ 4	Minor					
01	Bubble	$0.50 < \Phi \le 0.80$ 1 Ignore $\Phi > 0.80$ 5	WINOI					



◆Specification For TFT-LCD Module 3. 5″ ~15″:

NO	Item	Criterion	Level
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass X: The width of crack W: terminal length a: LCD side length	
		8. 1 General glass chip:8. 1. 1 Chip on panel surface and crack between panels:	
08	The crack of glass	SP Y [NG]	Minor
		Seal width Z	
		≤ a Crack can't exceed the half of SP width. 1/2 t < Z ≤2 t	



◆Specification For TFT-LCD Module 3. 5″~15″:

NO	Item	Criterion	Level					
1,0	100.11	Symbols:	Zever					
		X: The length of crack Z: The thickness of crack t: The thickness of glass Y: The width of crack. W: terminal length a: LCD side length						
		8.1.2 Corner crack:						
		X Y Z						
		$\leq 1/5$ a Crack can't enter viewing area $Z \leq 1/2$ t						
		$\leq 1/5$ a Crack can't exceed the half of SP width. $1/2$ t $<$ Z ≤ 2	? t					
08	The crack of glass	8.2 Protrusion over terminal:	Minor					
		8.2.1 Chip on electrode pad:						
		Z X Y Y X Y Y X Y Y Y Y Y Y Y Y Y Y Y Y	JZ ₹					
		W						
		X Y Z						
		Front $\leq a$ $\leq 1/2 \mathrm{W}$ $\leq t$						
		Back $\leq a$ $\leq W$ $\leq 1/2$	2 t					



◆Specification For TFT-LCD Module 3. 5″ ~15″:

NO	Item	Criterion	Level
NO 08	The crack of glass	Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 8. 2. 2 Non-conductive portion: X X Y Signature Signature X Y X X X X X X X X X X X	Level



◆Specification For TFT-LCD Module 3. 5″ ~15″:

NO	Item	Criterion	Level
		9. 1 Backlight can't work normally.	Major
09	Backlight elements	9. 2 Backlight doesn't light or color is wrong.	Major
		9. 3 Illumination source flickers when lit.	Major
		10. 1Pin type \quantity \quantity \dimension must match type in structure diagram.	Major
	General appearance	10. 2 No short circuits in components on PCB or FPC.	Major
		10. 3 Parts on PCB or FPC must be: no wrong parts, missing parts or excess parts.	Major
10		10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤1.5 mm.	Minor



4.1 **Reliability Test Condition**

NO.	TEST ITEM	TEST CONDITION					
1	High Temperature	_	Keep in +80 ±2°C 96 hrs				
	Storage Test	Surrounding temperature, then storage at normal condition 4hrs.					
2	Low Temperature	Keep in −30 ±2°C 96 hrs					
_	Storage Test	Surroundin	g temperature, then sto	rage at normal condition	on 4hrs.		
3	High Temperature / High Humidity Storage Test	_	$^{\circ}\!$		on 4hrs.		
			-30°C → +25°C -	→ +80°C → +25°C			
	Temperature Cycling		(30mins) (5mins)	(30mins) (5mins)			
4	Storage Test		10 C				
	D	Surroundin	g temperature, then sto		on 4hrs.		
		Air Dischar		Contact Discharge:	<u>-</u>		
	ESD Test			Apply 250 V with 5 tin	nes		
		111		discharge for each pola			
		1. Temperature ambiance : 15° C \sim 35° C					
_		2. Humidity relative: 30%~60%					
5		3. Energy Storage Capacitance(Cs+Cd): 150pF±10%					
		4. Discharge Resistance(Rd): 330Ω±10%					
		5. Discharge, mode of operation :					
		Single Discharge (time between successive discharges at least 1 sec)					
		(Tolerance	if the output voltage in	dication: ±5%)			
			1. Sine v	vave $10 \sim 55$ Hz fr	equency (1		
	Vibration Test		min/sw	eep)			
6	(Packaged)			plitude of vibration :1.	5 mm		
		3. Each di	rection (X \ Y \ Z) dura	•	V		
			Packing Weight (Kg)	Drop Height (cm)			
			0 ~ 45.4	122			
	Duon Tost		45.4 ~ 90.8	76			
7	Drop Test (Packaged)		90.8 ~ 454	61	-		
			Over 454	46			
]		
		Drop Direction: 1 corner / 3 edges / 6 sides each 1 time					



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.
- 5.2.10 Caution!(LCM products with Capacitive Touch Panel)
 Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).
 Therefore, the touch needs to be thoroughly tested inside the target application.
- 5.2.11 Do not let the LCD screen display static images (text, logos or pictures) for a prolonged period of time to prevent possible image burn-in.

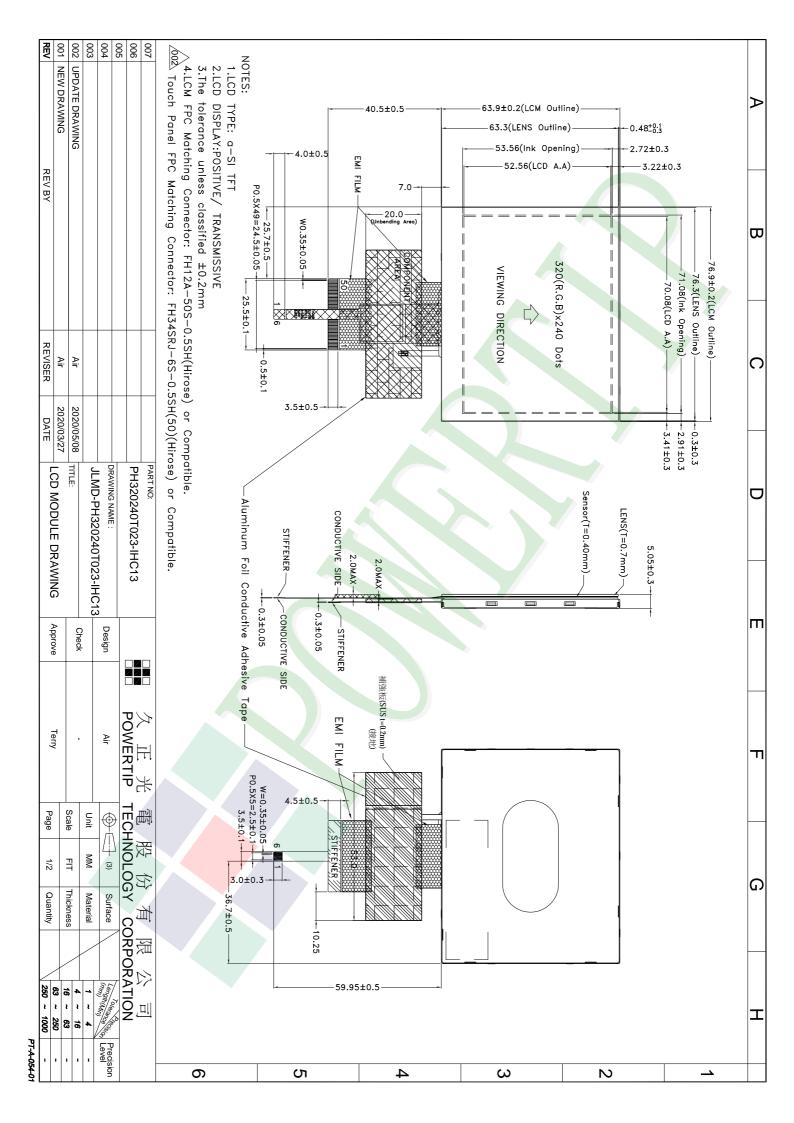
5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ±5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period

 The period is within thirteen month
 - The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
 - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Approve Check Contact Ver.001 LCM包裝規格書 LCM Packaging Specifications Terry Terry Air Documents NO. JPKG-PH320240T023-IHC13 (For Tray) 1.包裝材料規格表 (Packaging Material): (per carton) 1Pcs Weight No. Item Model Dimensions (mm) Ouantity Total Weight PH320240T023-IHC13 76.9X63.9X5.05 1 成品 (LCM) 0.0474 252 11.9448 2 多層薄膜(1)POF 19"X350X0.015 6 OTFILM0BA03ABA 3 352 X 260 X 12.3 48 TRAY 盤 (2)Tray TYSG000000137 0.1 4.8 4 内盒(3)Product Box BX36627063ABBA 393 X 274 X 68 0.182 6 1.092 5 OTPLB00PL08ABA 2 0.0568 保利龍板(4)Polylon board 550 X 393 X 20 0.0284 BX57041027CCBA 1 6 外紙箱(5)Carton 570 X 410 X 265 1.0 1.0 7 8 9 18.89 Kg±10% 2. 一整箱總重量 (Total LCD Weight in carton): 3.單箱數量規格表 (Packaging Specifications and Quantity): (1)LCM quantity per box: no per tray 6 x no of tray 7 42 (2)Total LCM quantity in carton: quantity per box x no of boxes 42 252 6 Use empty tray 空盤 (4)保利龍板 (1)多層薄膜 Polylon board POF Put products into the tray (2)TRAY 盤 Tray (5)外紙箱 Carton Tray stacking (3)内盒 Product Box POWERTE 特 記 事 項 (REMARK) 斜角 Detail B Tray 2 圓角 Tray 1 TRAY盤相疊時,需旋轉180度,請詳見B視圖 Rotate tray 180 degrees and place on top of stack. Check the tray stack using Fig. B.